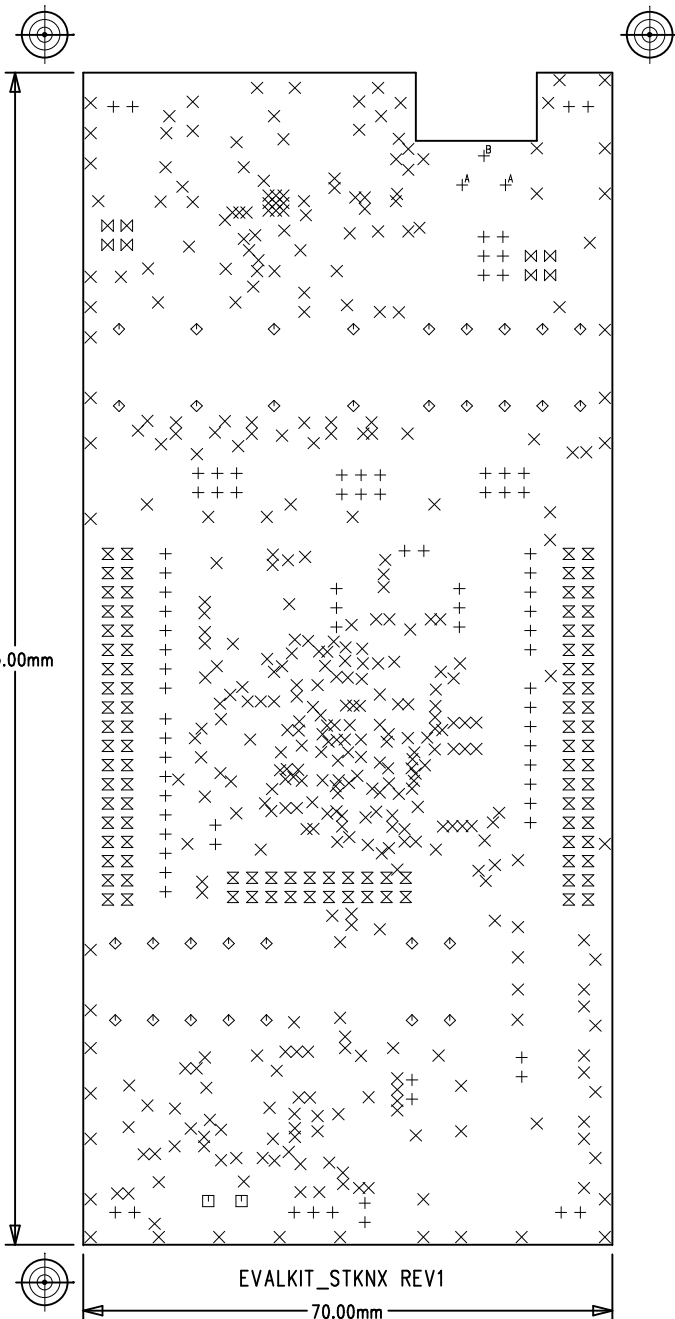




SIZE	QTY	SYM	PLATED	TOL
0.3	403	✕	YES	+/-0.1
0.889	8	⊠	YES	+/-0.1
0.9	96	⊠	YES	+/-0.1
0.9	2	□	NO	+/-0.1
1	83	+	YES	+/-0.0
1.2	1	⊕ ^B	NO	+/-0.1
1.2	2	⊕ ^A	YES	+/-0.1
1.96	32	◇	YES	+/-0.1

DRILL DRAWING

PRINTED BOARD SPECIFICATIONS (Under Standard : NFC 93-713)		
Zo	LAYERS	Trace/Isolation width
Item	Minimum Value (µm)	
Trace/Isolation	150/150	
Drill/Cu	300/700	
FINITION	NiAu	Ag
	☒	☐
Flat Pad	NO	
Filling Via	NO	

Vias	LAYER STACKUP	THICKNESS	FILE NAMES
VIA 1-4	PASTE MASK TOP	** none **	paste_top.pho
	SILKSCREEN TOP	** none **	silkscreen_top.pho
	SOLDER MASK TOP	** none **	solder_top.pho
	TOP	Cu 35 µm	top.pho
		FR-4 400 µm	
	LAYER 2	Cu 35 µm	layer2.pho
		FR-4 700 µm	
	LAYER 3	Cu 35 µm	layer3.pho
		FR-4 400 µm	
	BOTTOM	Cu 35 µm	bottom.pho
	SOLDER MASK BOTTOM	** none **	solder_bot.pho
	SILKSCREEN BOTTOM	** none **	silkscreen_bot.pho
	PASTE MASK BOTTOM	** none **	paste_bot.pho

UNLESS OTHERWISE SPECIFIED			COMPANY:		
DIMENSIONS ARE IN INCHES AND APPLY AFTER FINISH DIMENSIONS IN BRACKETS [] ARE IN MILLIMETERS INTERPRET DRAWING PER MIL-D-1000			 10 rue de Jouanet 35700 RENNES +33 2 23 47 04 04 www.st.com		
HOLE TOLERANCES PER 78027			NAME:		
		SURFACES	EVALKIT STKNX		BoardType
		MILLIMETERS			REV : 1.0
PART TO BE FREE OF BURRS			DESIGN	PGU	NOV'2017
			LAYOUT	AKK	NOV'2017
BEND RELIEF			SIZE	PART NUMBER:	
MAX			X		
DO NOT SCALE DRAWING			SCALE	1:1	FABRICATION DRAWING
			SHEET 1 OF 1		